

Product Summary (@T_A = +25°C)

V _{RRM} (V)	I _O (A)	V _{F(MAX)} (V)	I _{R(MAX)} (μA)
40	3	0.49	180

Features and Benefits

- Ultra-Low-Forward Voltage Drop
- Superior Forward Surge Capability
- Patented Interlocking Clip Design for High Surge Current Capacity
- Patented Super Barrier Rectifier Technology (SBR®)
- +150°C Operation Junction Temperature
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **The SBR3U40S1FQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF16949 certified facilities.**

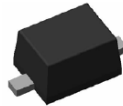
<https://www.diodes.com/quality/product-definitions/>

Description and Applications

The SBR3U40S1FQ is a single rectifier packaged in SOD123F, offering very low-forward voltage drop (V_F) and lower reverse leakage stability at high temperatures.

- DC-DC converters
- AC-DC rectifiers
- Reverse-polarity protections
- SMPS
- Blocking diodes

SOD123F



Top View

Mechanical Data

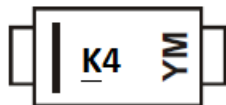
- Package: SOD123F
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (e3)
- Polarity: Cathode Band
- Weight: 0.0016 grams (Approximate)

Ordering Information (Note 4)

Orderable Part Number	Package	Packing	
		Qty.	Carrier
SBR3U40S1FQ-7	SOD123F	3000	Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



K4 = Product Type Marking Code
YM = Date Code Marking
Y = Year (ex: M = 2025)
M = Month (ex: 3 = March)

Date Code Key

Year	2016	-	2025	2026	2027	2028	2029	2030	2031	2032	2033	2034
Code	D	-	M	N	P	R	S	T	U	V	W	X

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM}	40	V
Average Rectified Output Current	I _O	3	A
Non-Repetitive Peak Forward Surge Current 8.3ms	I _{FSM}	50	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance Junction to Ambient (Note 5)	R _{θJA}	100	°C/W
Maximum Thermal Resistance Junction to Case (Note 5)	R _{θJC}	35	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V _F	—	0.35 0.44	0.39 0.49	V	I _F = 1A, T _J = +25°C I _F = 3A, T _J = +25°C
Leakage Current (Note 6)	I _R	—	70 16	180 60	μA mA	V _R = 40V, T _J = +25°C V _R = 40V, T _J = +125°C
Junction Capacitance	C _J	—	152	—	pF	V _R = 4V, T _J = +25°C
Reverse-Recovery Time	t _{RR}	—	11	—	ns	I _F = 0.5A, I _R = 1A I _{RR} = 0.25A

Notes: 5. Device mounted on FR-4 substrate, 0.4" x 0.5", 2oz, single-sided, PC boards with 0.2" x 0.25" copper pad.
6. Short duration pulse test used to minimize self-heating effect.

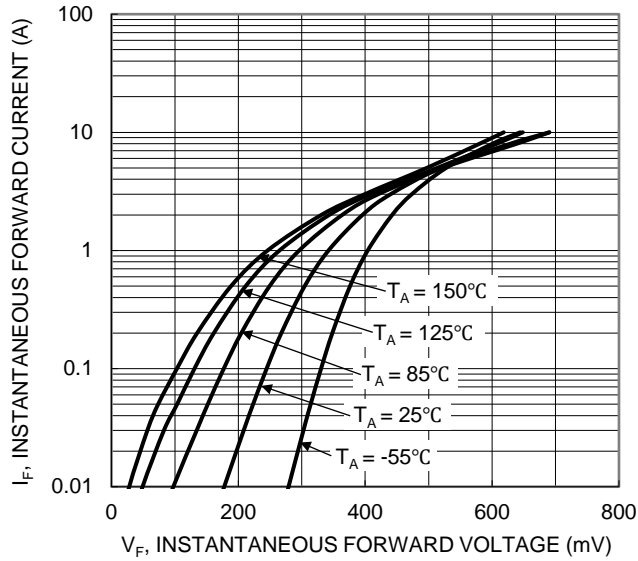


Figure 1. Typical Forward Characteristics

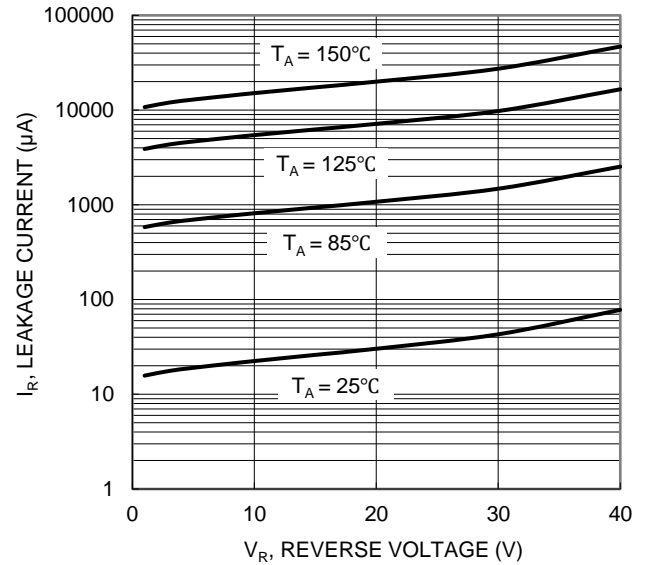


Figure 2. Typical Reverse Characteristics

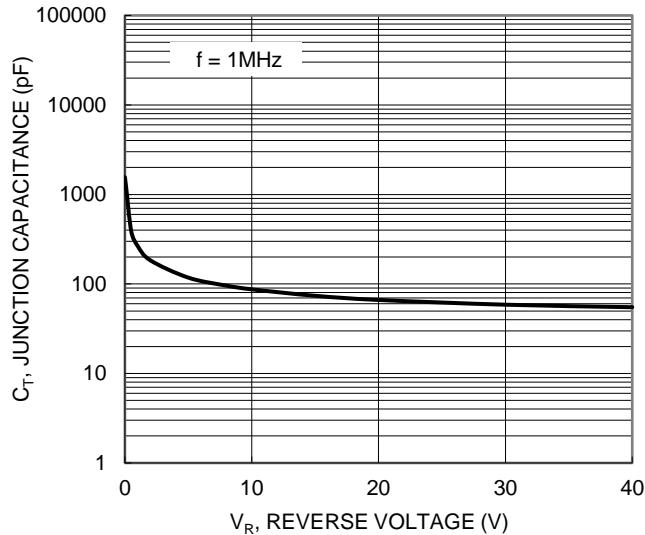


Figure 3. Typical Junction Capacitance

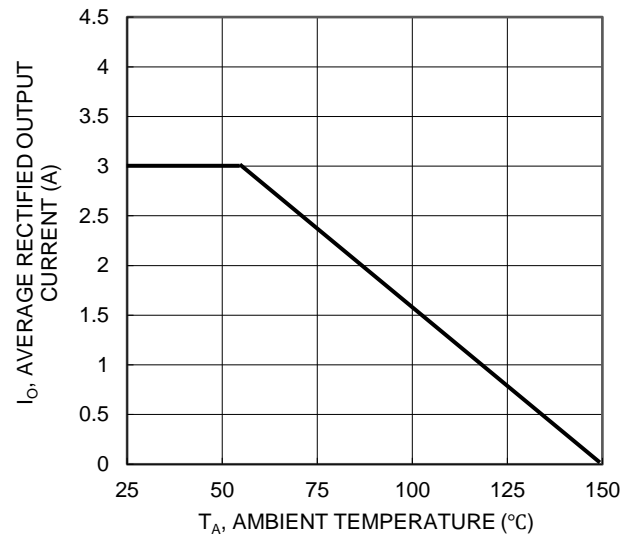


Figure 4. DC Forward Current Derating

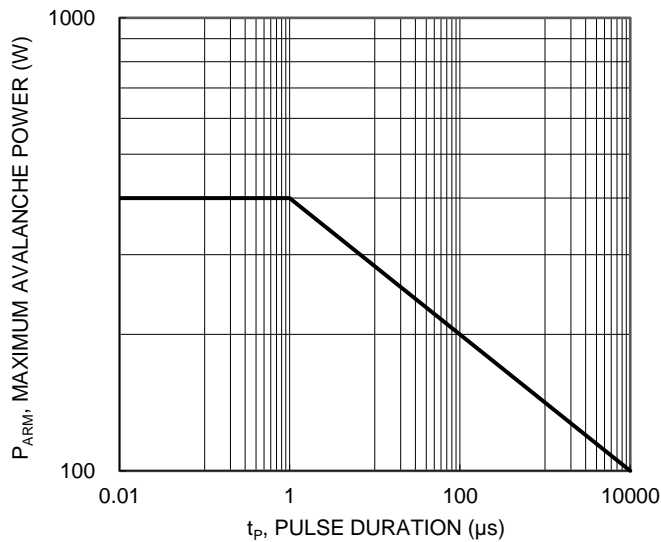
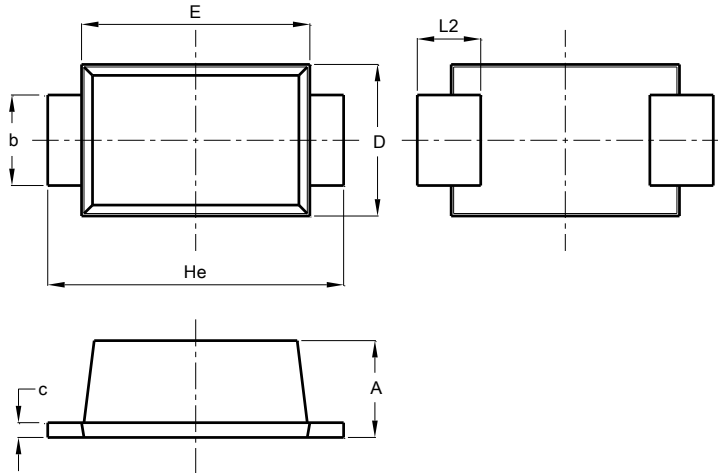


Figure 5. Maximum Avalanche Power

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOD123F

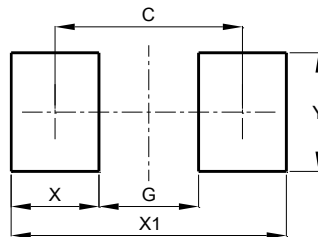


SOD123F			
Dim	Min	Max	Typ
A	0.81	1.15	-
b	0.80	1.05	-
c	0.05	0.30	-
D	1.70	1.90	1.80
E	2.60	2.80	2.70
He	3.30	3.70	3.50
L2	0.35	0.85	-
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOD123F



Dimensions	Value (in mm)
C	2.86
G	1.52
X	1.34
X1	4.20
Y	1.80

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